

H5N2503P

Silicon N Channel MOS FET High Speed Power Switching

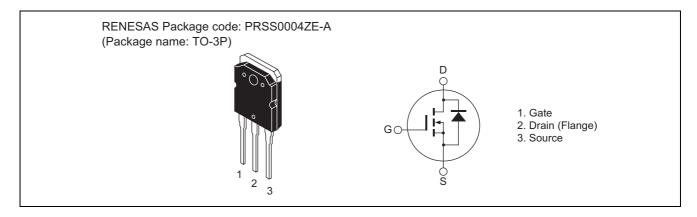
REJ03G1105-0200 (Previous: ADE-208-1374A)

> Rev.2.00 Sep 07, 2005

Features

- Low on-resistance: R $_{DS\ (on)}$ = 0.04 Ω typ.
- www.DataShee U Low leakage current: $I_{DSS} = 1 \mu A \text{ max (at } V_{DS} = 250 \text{ V)}$
 - High speed switching: $t_f = 190$ ns typ (at $V_{GS} = 10$ V, $V_{DD} = 125$ V, $I_D = 25$ A)
 - Low gate charge: Qg = 140 nC typ (at $V_{DD} = 200 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 50 \text{ A}$)
 - Avalanche ratings

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit
Drain to source voltage	V _{DSS}	250	V
Gate to source voltage	V _{GSS}	±30	V
Drain current	I _D	50	A
Drain peak current	I _{D (pulse)} Note 1	200	A
Body-drain diode reverse drain current	I _{DR}	50	A
Body-drain diode reverse drain peak current	I _{DR (pulse)} Note 1	200	A
Avalanche current	I _{AP} Note 3	50	A
Channel dissipation	Pch Note 2	150	W
Channel to case thermal Impedance	θ ch-c	0.833	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25°C

3. Tch ≤ 150°C

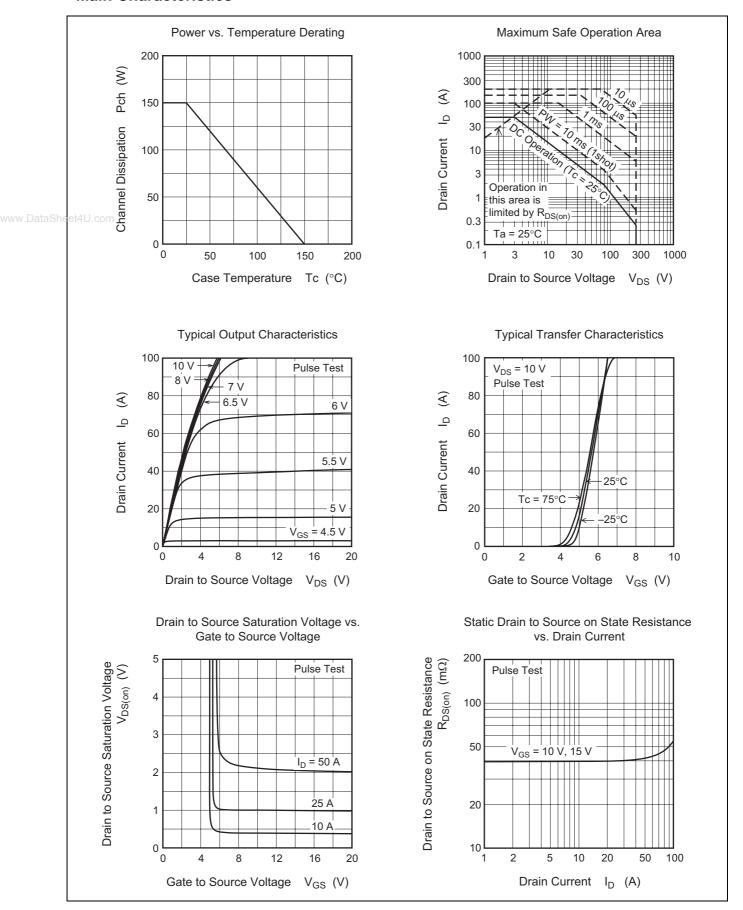
Electrical Characteristics

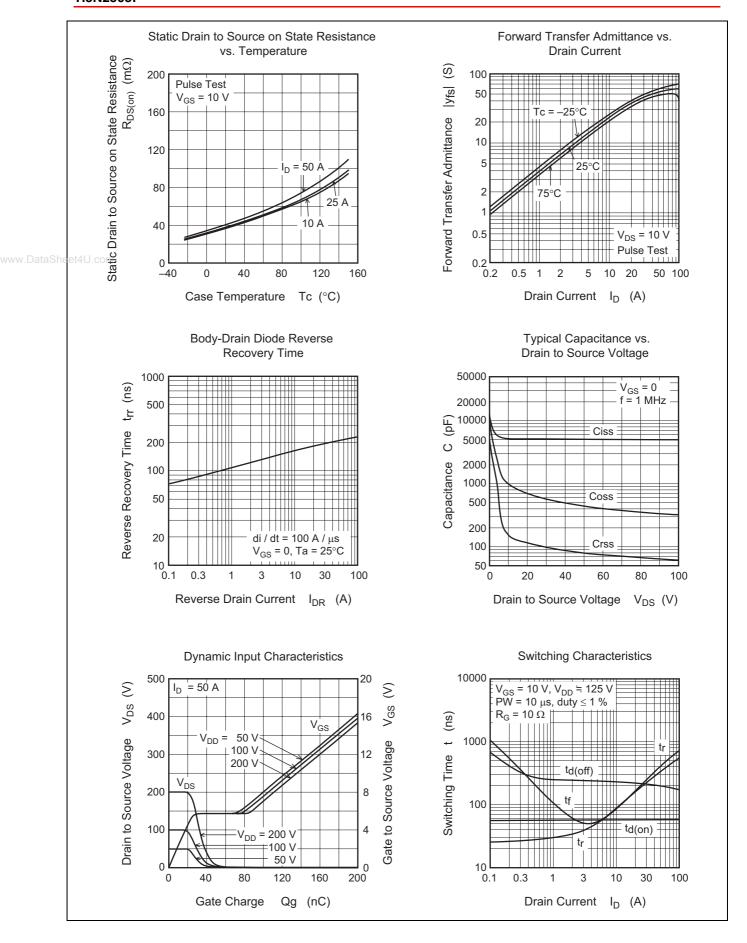
 $(Ta = 25^{\circ}C)$

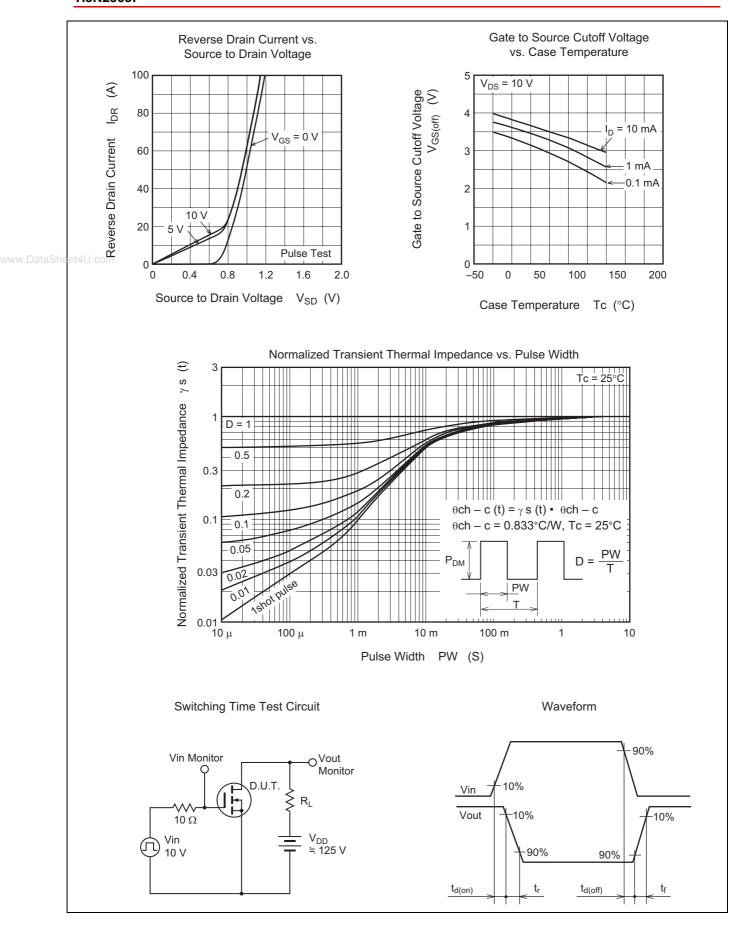
	(1u - 25 C)							
Item	Symbol	Min	Тур	Max	Unit	Test Conditions		
Drain to source breakdown voltage	V _{(BR) DSS}	250			V	$I_D = 10 \text{ mA}, V_{GS} = 0$		
Gate to source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$		
Zero gate voltage drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 250 \text{ V}, V_{GS} = 0$		
Gate to source cutoff voltage	V _{GS (off)}	3.0	_	4.0	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$		
Static drain to source on state resistance	R _{DS (on)}	_	0.040	0.055	Ω	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note 4}}$		
Forward transfer admittance	y _{fs}	25	40	_	S	$I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note 4}}$		
Input capacitance	Ciss	_	5150	_	pF	V _{DS} = 25 V		
Output capacitance	Coss	_	620	_	pF	$V_{GS} = 0$		
Reverse transfer capacitance	Crss	_	105	_	pF	f = 1 MHz		
Turn-on delay time	t _{d (on)}	_	58	_	ns	I _D = 25 A		
Rise time	t _r	_	210	_	ns	V _{GS} = 10 V		
Turn-off delay time	t _{d (off)}	_	220	_	ns	$R_L = 5 \Omega$		
Fall time	t _f	_	190	_	ns	$Rg = 10 \Omega$		
Total gate charge	Qg	_	140	_	nC	V _{DD} = 200 V		
Gate to source charge	Qgs	_	25	_	nC	V _{GS} = 10 V		
Gate to drain charge	Qgd	_	60	_	nC	I _D = 50 A		
Body-drain diode forward voltage	V_{DF}	_	1.0	1.5	V	$I_F = 50 \text{ A}, V_{GS} = 0$		
Body-drain diode reverse recovery time	t _{rr}	_	210	_	ns	$I_F = 50 \text{ A}, V_{GS} = 0$		
Body-drain diode reverse recovery charge	Q _{rr}	_	1.8	_	μС	di _F /dt = 100 A/μs		

Note: 4. Pulse test

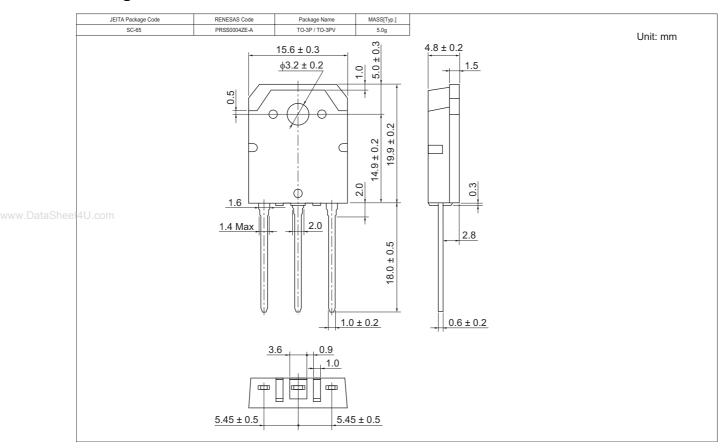
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
H5N2503P-E	360 pcs	Box (Tube)

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